

SANYO

No.3379A

LC5732N**4-Bit Microcomputer with LCD Driver****Overview**

The LC5732N is a CMOS 4-bit microcomputer that operate on low voltage, very low current and contain LCD drivers. They also contain a 4-bit parallel processing ALU, a program memory ROM, many LCD segment outputs, a prescaler, an oscillator.

The LC5732N is especially suited for use in high-grade timepieces, time controllers, electronic calculators, LCD games with timepiece.

Hardware Features

- Supply voltage :
1.5V or 3.0V typ. (mask option-selectable)
- Very low current dissipation :
3.0 μ A typ. (Ag battery version, 32kHz crystal oscillation, during timekeeping operation)
1.5 μ A typ. (Li battery version, 32kHz crystal oscillation, during timekeeping operation)
- Crystal oscillator for timekeeping (32.768kHz crystal connected externally) or CR oscillator (CR connected externally)
- Many output pins for LCD panel drive (27 pins)

Drivable LCD panel		Number of drivable LCD segments
1/2 bias	1/3 duty	81 segments
1/2 bias	1/2 duty	54 segments
Static		27 segments
- On-chip melody function : 3 octaves (The melody length is software-controlled. One musical note requires one byte.)
- Input/output pins
 - Input pins : 8 pins
 - Control output pins : 3 pins (Output dedicated to alarm : 2 pins, general-purpose output : 1 pin)
- Possible to use LCD panel drive output pins as output-only ports (mask option-selectable)
- ROM : 2048 \times 8 bits
- RAM : 48 \times 4 bits
- Cycle time : 122 μ sec. for 32.768kHz crystal
- On-chip step-up circuit/step-down circuit
- Shipping style : Chip

Software Features

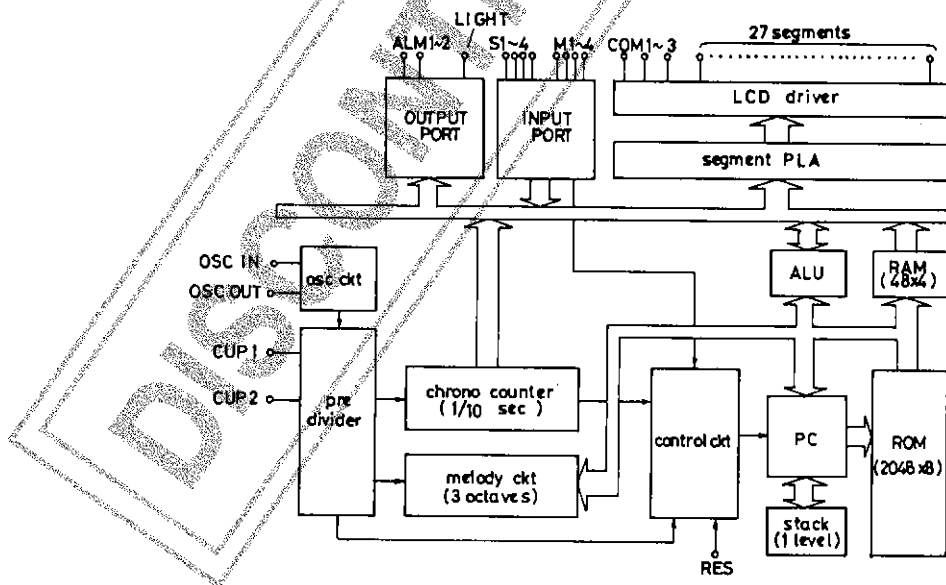
- Powerful instruction set : 92 instructions
- Table read instruction
- 1-level subroutine nesting
- On-chip 15-bit divider for timekeeping (delivers an overflow signal every 32ms or 64ms/100ms/500ms when a 32.768kHz crystal is used.)
- HALT function

Application Development Support System

- Evaluation chip (LC5797) is available for application development and the dedicated equipment is available as the application development tools.
- Tools for developing the LC5732N application programs
 - ① · MS-DOS machine
 - Cross Assembler : LC5732.EXE
 - Mask Option selections program : SU5732.EXE
 - ② · SDS-410 system
 - Cross-Assembler : LC5732.COM
 - Mask Option selections program : SU5732.COM
- EVA-510 + TB-5734 + DCB-1 (Rev 2.0V or greater) + Application evaluation board + LC5797
By connecting to the SDS-410 or MS-DOS machine, application development program data correction and debugging may be done.
- TB-5734 + DCB-1 (Rev 2.0V or greater) + Application evaluation board + LC5797
By using the EPROM (2732) with application development program data written in, mounting evaluation may be done.

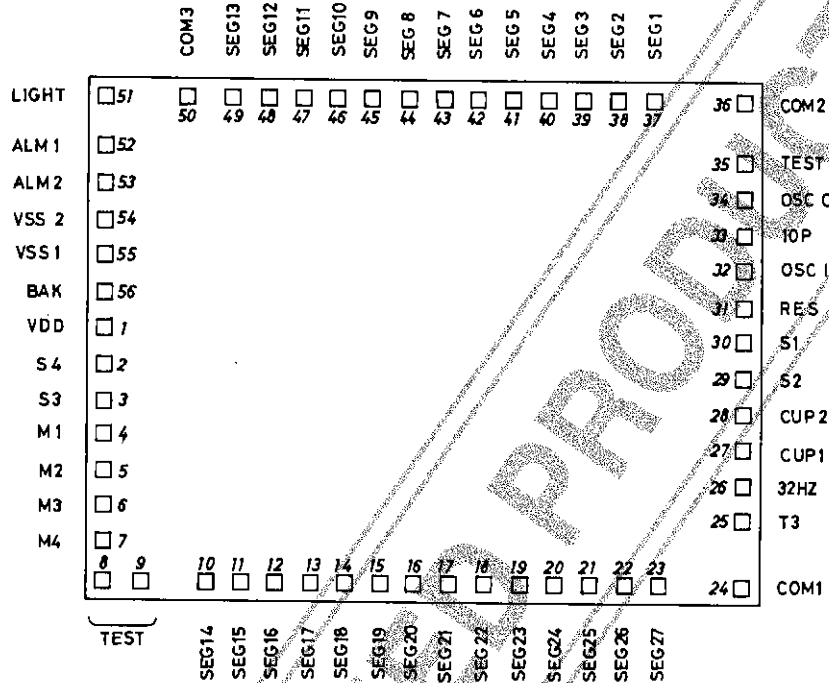
- Note 1
- The application evaluation board is constructed by the user.
 - LEDs or LCDs may be used for display.
 - The EVA-510 is a modified version of the EVA-410 whose monitor ROM is replaced by the SCR-5734.
- Note 2
- Since the evaluation chip LC5797 and the LC5732N differ in RAM capacity, check the ROM capacity when developing or debugging programs.
 - LC5732N : 48 × 4 bits
 - LC5797 : 256 × 4 bits
 - If the DPH value on a program is other than 0, 1, 2, the LC5732N will malfunction in actual applications.
 - When developing programs, take care of the DPH value. The usable DPH values are "0", "1", "2" only.
 - We will be free from any blame even if you use DPH = other than 0 to 2 to develop programs.
 - User's Manual : "LC5732/32H, 5733/33H, 5734/34H User's Manual"
Refer to the LC5732 section of this User's Manual.
 - Development Tool Manual : "LC5730 Series Development Tool Manual"
Refer to the LC5732 section of this Development Tool Manual.

Equivalent Circuit Block Diagram



Pad Assignment of LSI Chip

Chip size : 3.72mm × 3.11mm
 Chip thickness : 480µm
 Pad size : 120µm × 120µm



(Note) SEG14 to SEG27 can be used for output ports. (mask option-selectable)

Pad Name and Coordinates

Pad No	Pin Name	X (μm)	Y (μm)	Pad No	Pin Name	X (μm)	Y (μm)
1	VDD	-1665	90	29	S 2	1665	-260
2	S 4	-1665	-90	30	S 1	1665	-55
3	S 3	-1665	-295	31	RES	1665	150
4	M 1	-1665	-500	32	OSCIN	1665	410
5	M 2	-1665	-700	33	10P	1665	635
6	M 3	-1665	-905	34	OSCOUT	1665	840
7	M 4	-1665	-1110	35	TEST	1665	1045
8	TEST	-1665	-1360	36	COM 2	1665	1360
9	TEST	-1340	-1360	37	SEG 1	1150	1360
10	SEG14	-1100	-1360	38	SEG 2	970	1360
11	SEG15	-920	-1360	39	SEG 3	790	1360
12	SEG16	-740	-1360	40	SEG 4	610	1360
13	SEG17	-560	-1360	41	SEG 5	430	1360
14	SEG18	-380	-1360	42	SEG 6	250	1360
15	SEG19	-200	-1360	43	SEG 7	70	1360
16	SEG20	-20	-1360	44	SEG 8	-110	1360
17	SEG21	160	-1360	45	SEG 9	-290	1360
18	SEG22	340	-1360	46	SEG10	-470	1360
19	SEG23	520	-1360	47	SEG11	-650	1360
20	SEG24	700	-1360	48	SEG12	-830	1360
21	SEG25	880	-1360	49	SEG13	-1010	1360
22	SEG26	1060	-1360	50	COM 3	-1190	1360
23	SEG27	1240	-1360	51	LIGHT	-1665	1360
24	COM 1	1665	-1360	52	ALM 1	-1665	990
25	T 3	1665	-1075	53	ALM 2	-1665	810
26	32Hz	1665	-875	54	VSS 2	-1665	630
27	CUP 1	1665	-670	55	VSS 1	-1665	450
28	CUP 2	1665	-465	56	BAK	-1665	270

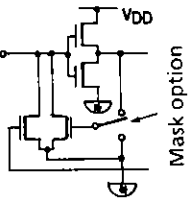
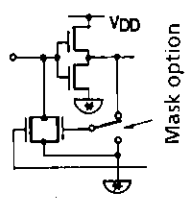
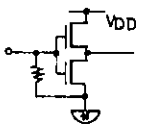
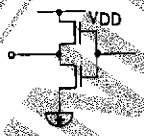
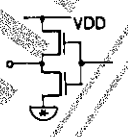
The pad coordinates are such that the chip center is taken as the origin and the values for (X, Y) represent the coordinates of the center point of each pad.

Pin Description

Pad No.	Pin Name	Input/Output	Circuit Configuration	Function
32	OSCIN	Input		<p>Crystal OSC mode 32.768kHz crystal is connected across OSCIN and OSCOUT for oscillation. Used as reference clock for timepiece and system clock.</p>
34	OSCOUT	Output		<p>CR OSC mode R and C are connected across OSCIN and OSCOUT for oscillation. Used as system clock.</p>
33	10P			<p>Connected to OSCOUT and used as OSC phase compensation capacitor.</p>

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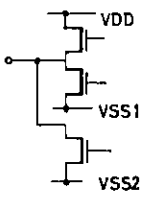
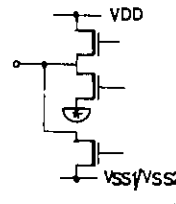
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Pad No.	Pin Name	Input/Output	Circuit Configuration	Function																																		
30 29 3 2	S1 S2 S3 S4	Input		Input-only port. LSI system is reset by applying V _{DD} to S1 to S4 simultaneously. Note (Operating from Li battery, the RES pin must be used in both.)																																		
4 5 6 7	M1 M2 M3 M4	Input		Input pins for placing data in LSI.																																		
31	RES	Input		Input pin for resetting LSI system.																																		
56	BAK			(-) power supply pin for logic unit inside the LSI. For Li battery version, a capacitor must be connected across BAK and V _{DD} to prevent logic unit from malfunctioning.																																		
51	LIGHT	Output		Output-only pin Suited for driving transistor for light.																																		
52 53	ALM1 ALM2	Output		Output-only pin Used to deliver *4kHz, 2kHz, 1kHz modulation signal with instruction. Also used to deliver non-modulation signal. Used to deliver melody signal of 3 octaves with instruction.																																		
1	V _{DD}			(+) power supply pin.																																		
54 55	V _{SS2} V _{SS1}			(-) power supply pin. Ag battery version, Li battery version, EXT-V version : mask option selectable. Also used as power supply for LCD drive. The following Table shows how to connect external parts in each case.																																		
<table border="1" data-bbox="917 1769 1348 1926"> <thead> <tr> <th rowspan="2"></th> <th colspan="2">Ag bat. use</th> <th colspan="2">Li bat. use</th> <th colspan="2">EXT-V use</th> </tr> <tr> <th>static</th> <th>1/2 bias</th> <th>static</th> <th>1/2 bias</th> <th>static</th> <th>1/2 bias</th> </tr> </thead> <tbody> <tr> <td>V_{DD}</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> </tr> <tr> <td>V_{SS1}</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> </tr> <tr> <td>V_{SS2}</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> </tr> </tbody> </table>						Ag bat. use		Li bat. use		EXT-V use		static	1/2 bias	static	1/2 bias	static	1/2 bias	V _{DD}							V _{SS1}							V _{SS2}						
	Ag bat. use		Li bat. use			EXT-V use																																
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V _{DD}																																						
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V _{SS2}																																						
27 28	CUP1 CUP2			Pins for connecting voltage step-up (step-down) capacitor.																																		

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Pad No.	Pin Name	Input/Output	Circuit Configuration	Function																				
24 36 50	COM1 COM2 COM3	Output		<p>Output pins for LCD panel common plate. The following pin is used in each case.</p> <table border="1"> <thead> <tr> <th></th> <th>Static</th> <th>1/2 duty</th> <th>1/3 duty</th> </tr> </thead> <tbody> <tr> <td>COM1</td> <td>○</td> <td>○</td> <td>○</td> </tr> <tr> <td>COM2</td> <td></td> <td>○</td> <td>○</td> </tr> <tr> <td>COM3</td> <td></td> <td></td> <td>○</td> </tr> <tr> <td>Alternating frequency</td> <td>64Hz</td> <td>32Hz</td> <td>43Hz</td> </tr> </tbody> </table> <p>(Alternating frequency is for 32.768kHz crystal OSC application.)</p>		Static	1/2 duty	1/3 duty	COM1	○	○	○	COM2		○	○	COM3			○	Alternating frequency	64Hz	32Hz	43Hz
	Static	1/2 duty	1/3 duty																					
COM1	○	○	○																					
COM2		○	○																					
COM3			○																					
Alternating frequency	64Hz	32Hz	43Hz																					
10 to 23 37 to 49	Segment driver	Output		<p>Output pins for LCD panel segments. Mask option permits Seg 14 to Seg 27 (pad No.10 to 23) to be used as output ports.</p>																				
26 25 35 8 9	32Hz T3 TEST	Test		<p>Test pins (not used by user)</p>																				

(Note) For Ag battery power supply, \oplus is connected to V_{SS1} ; for Li battery/EXT-V power supply, connected to V_{SS2} .

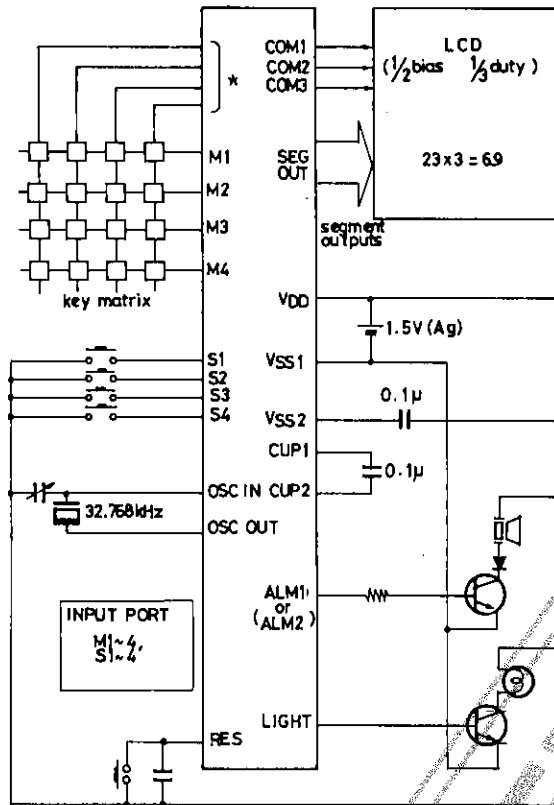
* 4kHz, 2kHz, 1kHz : For 32.768kHz crystal OSC application, proportional to OSC frequency.

DISCONTINUED PRODUCT

Sample Application Circuits

(1) Ag Battery used application

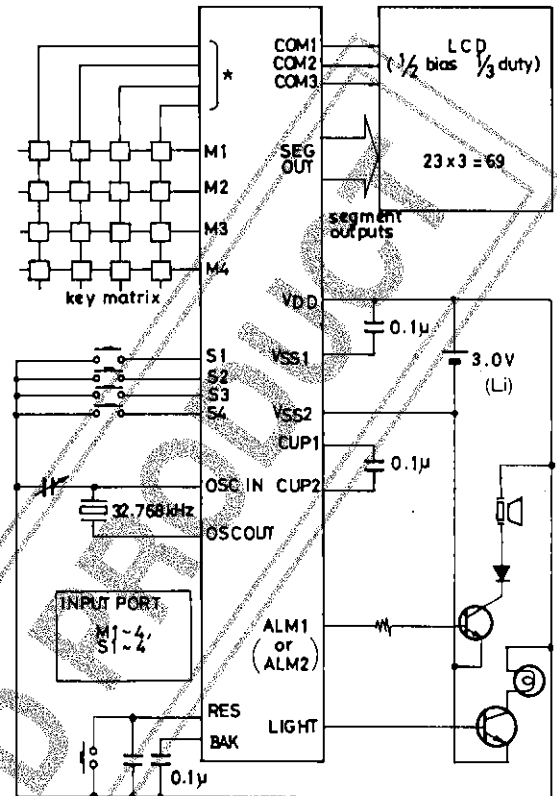
(1/2 bias 1/3 duty) * : 4 segment outputs are used for output ports.



Crystal OSC (Power supply : Ag battery version)

(2) Li Battery used application

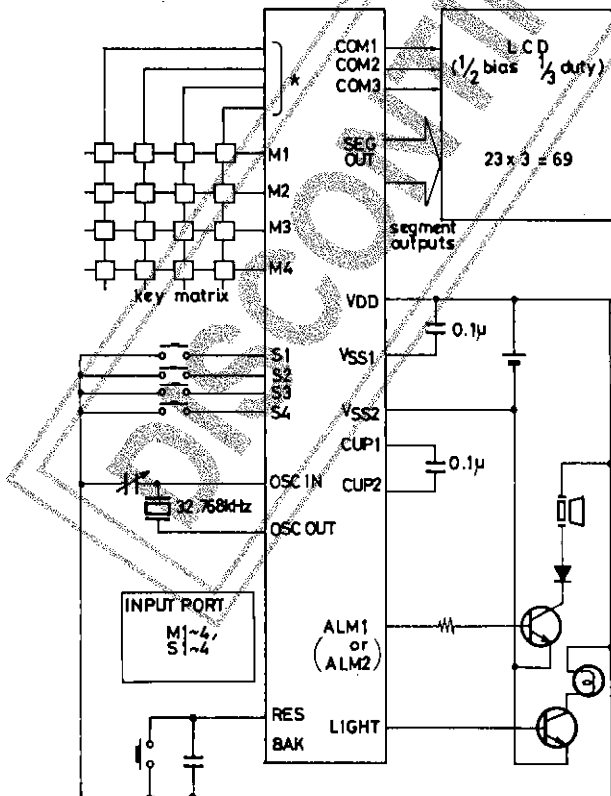
(1/2 bias 1/3 duty) * : 4 segment outputs are used for output ports.



Crystal OSC (Power supply : Li battery version)

(3) EXT-V used application

(1/2 bias 1/3 duty) * : 4 segment outputs are used for output ports.



Crystal OSC (Power supply : EXT-V version)

Unit (capacitance: F)

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● Ag Battery Version

Absolute Maximum Ratings at Ta = 25 ± 2°C, VDD = 0V

				unit
Maximum Supply Voltage	VSS1		-4.0 to +0.3	V
	VSS2		-4.0 to +0.3	V
Maximum Input Voltage	VIN	S1-4, M1-4, TEST, OSCIN, RES	VSS1 -0.3 to +0.3	V
Maximum Output Voltage	VOUT1	CUP2, OSCOUT, ALM1, ALM2, LIGHT	VSS1 -0.3 to +0.3	V
	VOUT2	SEGOUT, COM1, COM2, COM3, CUP1	VSS2 -0.3 to +0.3	V
Operating Temperature	Topr		-10 to +65	°C
Storage Temperature	Tstg		-30 to +125	°C

Allowable Operating Conditions at Ta = 25 ± 2°C, VDD = 0V

			min	typ	max	unit
Supply Voltage	VSS1		-1.65		-1.30	V
	VSS2		-3.3		-2.4	V
Input 'H'-Level Voltage	VIH	S1-4, M1-4, RES	-0.2		0	V
Input 'L'-Level Voltage	VIL	S1-4, M1-4, RES	VSS1		VSS1 + 0.2	V
Operating Frequency	fopg1	Ta = -10 to +65°C, crystal OSC (recommended OSC circuit Fig. 7)	32		33	kHz
	fopg2	Ta = -10 to +65°C, CR OSC (recommended OSC circuit Fig. 8)		32.768		kHz

(Recommended external CR constant: Cext = 33pF, Rext = 510kΩ)

Electrical Characteristics at Ta = 25 ± 2°C, VDD = 0V

			min	typ	max	unit
Input Resistance	RIN1A	VSS1 = -1.55V, VIL = VSS1 + 0.2V, 'L' level hold tr., *1, Fig.1	200		2000	kΩ
	RIN1B	VSS1 = -1.55V, 'L' level pull-in tr., *1, Fig.1	200		2000	kΩ
	RIN2	VSS1 = -1.55V, TEST, RES	10		300	kΩ
Output 'H'-Level Voltage	VOH1	VSS1 = -1.55V, IOH = -0.4μA, *2	-0.2			V
Output 'L'-Level Voltage	VOL1	VSS1 = -1.55V, IOL = 0.4μA, *2			VSS2 + 0.2	V
Output 'H'-Level Voltage	VOH2	VSS1 = -1.55V, IOH = -4μA, COM1, COM2, COM3	-0.2			V
Output 'M'-Level Voltage	VOM	VSS1 = -1.55V, IOH = -4μA, IOL = 4μA, COM1, COM2, COM3	VSS1 - 0.2		VSS1 + 0.2	V
Output 'L'-Level Voltage	VOL2	VSS1 = -1.55V, IOL = 4μA, COM1, COM2, COM3			VSS2 + 0.2	V
Output 'H'-Level Voltage	VOH3	VSS1 = -1.35V, IOH = -250μA, ALM1, ALM2, LIGHT	-0.65			V
Output 'L'-Level Voltage	VOL3	VSS1 = -1.35V, IOL = 150μA, ALM1, ALM2, LIGHT			VSS1 + 0.65	V
Output 'H'-Level Voltage	VOH4	VSS1 = -1.55V, IOH = -20μA, *3	-0.2			V
Output 'L'-Level Voltage	VOL4	VSS1 = -1.55V, IOL = 20μA, *3			VSS1 + 0.2	V
Output Voltage	VSS2	VSS1 = -1.35V, C1 = C2 = 0.1μF, fopg = 32.768kHz, Fig. 2	-3.3		-2.5	V
Current Dissipation	IDD1	VSS1 = -1.55V, C1 = C2 = 0.1μF, Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig. 2, backup flag OFF			2.0	μA
	IDD2	HALT mode			5.0	μA
		ROM continue mode				
Oscillation Start Voltage	Vstt	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig. 3	-1.35			V
Oscillation Hold Voltage	VHOLD	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig. 3			-1.30	V
Oscillation Start Time	tstt	VSS1 = -1.35V, Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig. 3			10	s
Oscillation Compensation Capacitance	10P	External pin	8	10	12	pF

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● Li Battery Version

Absolute Maximum Ratings at Ta = 25 ± 2°C, VDD = 0V

				unit
Maximum Supply Voltage	VSS1		-4.0 to +0.3	V
	VSS2		-4.0 to +0.3	V
Maximum Input Voltage	VIN1	OSCIN	VSS1 - 0.3 to +0.3	V
	VIN2	S1-4, M1-4, TEST, RES	VSS2 - 0.3 to +0.3	V
Maximum Output Voltage	VOUT1	CUP2, OSCOUT	VSS1 - 0.3 to +0.3	V
	VOUT2	SEGOUT, COM1, COM2, COM3, CUP1, LIGHT, ALM1, ALM2	VSS2 - 0.3 to +0.3	V
Operating Temperature	Topr		-10 to +65	°C
Storage Temperature	Tstg		-30 to +125	°C

Allowable Operating Conditions at Ta = 25 ± 2°C, VDD = 0V

			min	typ	max	unit
Supply Voltage	VSS1		-3.6		-1.3	V
	VSS2		-3.6		-2.0	V
Input 'H'-Level Voltage	VIH	S1-4, M1-4, RES	-0.4		0	V
Input 'L'-Level Voltage	VIL	S1-4, M1-4, RES	VSS2		VSS2 + 0.4	V
Operating Frequency	fopg1	Ta = -10 to +65°C, crystal OSC (recommended OSC circuit Fig.7)	32		33	kHz

Electrical Characteristics at Ta = 25 ± 2°C, VDD = 0V

			min	typ	max	unit
Input Resistance	RIN1A	VSS2 = -2.9V, VIL = VSS2 + 0.4V, 'L' level hold tr., *1, Fig.4	200		2000	kΩ
	RIN1B	VSS2 = -2.9V, 'L' level pull-in tr., *1, Fig.4	100		2000	kΩ
	RIN2	VSS2 = -2.9V, TEST, RES	10		300	kΩ
Output 'H'-Level Voltage	VOH1	VSS2 = -2.9V, IOH = -0.4μA, *2	-0.2			V
Output 'L'-Level Voltage	VOL1	VSS2 = -2.9V, IOL = 0.4μA, *2			VSS2 + 0.2	V
Output 'H'-Level Voltage	VOH2	VSS2 = -2.9V, IOH = -4μA, COM1, COM2, COM3	-0.2			V
Output 'M'-Level Voltage	VOM	VSS2 = -2.9V, IOH = -4μA, IOL = 4μA, COM1, COM2, COM3	VSS2/2 - 0.2		VSS2/2 + 0.2	V
Output 'L'-Level Voltage	VOL2	VSS2 = -2.9V, IOL = 4μA, COM1, COM2, COM3			VSS2 + 0.2	V
Output 'H'-Level Voltage	VOH3	VSS2 = -2.4V, IOH = -250μA, ALM1, ALM2	-0.65			V
Output 'L'-Level Voltage	VOL3	VSS2 = -2.4V, IOL = 250μA, ALM1, ALM2			VSS2 + 0.65	V
Output 'H'-Level Voltage	VOH4	VSS2 = -2.4V, IOH = -150μA, LIGHT	-1.5			V
Output 'L'-Level Voltage	VOL4	VSS2 = -2.4V, IOL = 150μA, LIGHT			VSS2 + 1.5	V
Output 'H'-Level Voltage	VOH5	VSS2 = -2.9V, IOH = -40μA, *3	-0.4			V
Output 'L'-Level Voltage	VOL5	VSS2 = -2.9V, IOL = 40μA, *3			VSS2 + 0.4	V
Output Voltage (halver)	VSS1	VSS2 = -2.8V, C1 = C2 = 0.1μF, fopg = 32.768kHz, Fig.5			-1.35	V
Current Dissipation	IDD1	VSS2 = -2.9V, C1 = C2 = 0.1μF, crystal OSC] HALT mode			0.8	μA
	IDD2	(CI ≤ 25kΩ), Cg = 20pF, Fig.5, backup flag OFF] ROM continue mode			2.0	μA
Oscillation Start Voltage	Vstt	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig.6	-1.35			V
Oscillation Hold Voltage	VHOLD	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig.6			-1.3	V
Oscillation Start Time	tstt	VSS2 = -1.35V, Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig.6			10	s
Oscillation Compensation Capacitance	10P	External pin	8	10	12	pF

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● EXT-V Version

Absolute Maximum Ratings at Ta = 25 ± 2°C, V_{DD} = 0V

				unit
Maximum Supply Voltage	V _{SS1}		-4.0 to +0.3	V
	V _{SS2}		-4.0 to +0.3	V
Maximum Input Voltage	V _{IN}	OSCIN, S1-4,M1-4,TEST,RES	V _{SS2} - 0.3 to +0.3	V
Maximum Output Voltage	V _{OUT}	CUP2, OSCOUT, SEGOUT, COM1, COM2, COM3, CUP1, LIGHT, ALM1, ALM2	V _{SS2} - 0.3 to +0.3	V
Operating Temperature	T _{opr}		-30 to +70	°C
Storage Temperature	T _{stg}		-40 to +125	°C

Allowable Operating Conditions at Ta = 25 ± 2°C, V_{DD} = 0V

			min	typ	max	unit
Supply Voltage	V _{SS1}		-3.6		-1.3	V
	V _{SS2}		-3.6		-2.0	V
Input 'H'-Level Voltage	V _{IH}	S1-4,M1-4,RES	-0.4		0	V
Input 'L'-Level Voltage	V _{IL}	S1-4,M1-4,RES	V _{SS2}		V _{SS2} + 0.4	V
Operating Frequency	f _{opg1}	Ta = -30 to +70°C, crystal OSC (recom- mended OSC circuit Fig.7)	32		33	kHz
	f _{opg2}	Ta = -30 to +70°C, CR OSC (recom- mended OSC circuit Fig.8)		32.768		kHz
(Recommended external CR constant: C = 27pF, R = 680kΩ)						

Electrical Characteristics at Ta = 25 ± 2°C, V_{DD} = 0V

			min	typ	max	unit
Input Resistance	R _{IN1A}	V _{SS2} = -2.9V, V _{IL} = V _{SS2} + 0.4V, 'L' level hold tr., *1, Fig.4	200		2000	kΩ
	R _{IN1B}	V _{SS2} = -2.9V, 'L' level pull-in tr., *1, Fig.4	100		2000	kΩ
	R _{IN2}	V _{SS2} = -2.9V, TEST, RES	10		300	kΩ
Output 'H'-Level Voltage	V _{OH1}	V _{SS2} = -2.9V, I _{OH} = -0.4μA, *2	-0.2			V
Output 'L'-Level Voltage	V _{OL1}	V _{SS2} = -2.9V, I _{OL} = 0.4μA, *2			V _{SS2} + 0.2	V
Output 'H'-Level Voltage	V _{OH2}	V _{SS2} = -2.9V, I _{OH} = -4μA, COM1, COM2, COM3	-0.2			V
Output 'M'-Level Voltage	V _{OM}	V _{SS2} = -2.9V, I _{OH} = -4μA, I _{OL} = 4μA, COM1, COM2, COM3	V _{SS2} /2 - 0.2		V _{SS2} /2 + 0.2	V
Output 'L'-Level Voltage	V _{OL2}	V _{SS2} = -2.9V, I _{OL} = 4μA, COM1, COM2, COM3			V _{SS2} + 0.2	V
Output 'H'-Level Voltage	V _{OH3}	V _{SS2} = -2.4V, I _{OH} = -250μA, ALM1, ALM2	-0.65			V
Output 'L'-Level Voltage	V _{OL3}	V _{SS2} = -2.4V, I _{OL} = 250μA, ALM1, ALM2			V _{SS2} + 0.65	V
Output 'H'-Level Voltage	V _{OH4}	V _{SS2} = -2.4V, I _{OH} = -150μA, LIGHT	-1.5			V
Output 'L'-Level Voltage	V _{OL4}	V _{SS2} = -2.4V, I _{OL} = 150μA, LIGHT			V _{SS2} + 1.5	V
Output 'H'-Level Voltage	V _{OH5}	V _{SS2} = -2.9V, I _{OH} = -40μA, *3	-0.4			V
Output 'L'-Level Voltage	V _{OL5}	V _{SS2} = -2.9V, I _{OL} = 40μA, *3			V _{SS2} + 0.4	V
Output Voltage (halver)	V _{SS1}	V _{SS2} = -2.8V, C1 = C2 = 0.1μF, f _{opg} = 32.768kHz, Fig.5			-1.35	V
Current Dissipation	I _{DD1}	V _{SS2} = -2.9V, C1 = C2 = 0.1μF, crystal OSC (CI ≤ 25kΩ), Cg = 20pF, Fig.5	HALT mode		5.0	μA
	I _{DD2}		ROM continue mode		12.5	μA
Oscillation Start Voltage	V _{stt}	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig.6	-2.2			V
Oscillation Hold Voltage	V _{HOLD}	Cg = 20pF, crystal OSC (CI ≤ 25kΩ), Fig.6			-2.0	V

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			min	typ	max	unit
Oscillation Start Time	t_{stt}	$V_{SS2} = -2.2V, C_g = 20pF,$ crystal OSC ($C_I \leq 25k\Omega$), Fig.6				10 sec
Oscillation Compensation Capacitance	10P	External pin	8	10	12	pF

- ※ 1 S1, S2, S3, S4 ; M1, M2, M3, M4
- ※ 2 LCD driver output pins out of SEGOUT14 to 27, SEGOUT1 to 13
- ※ 3 Output pins (used as output port) of SEGOUT14 to 27

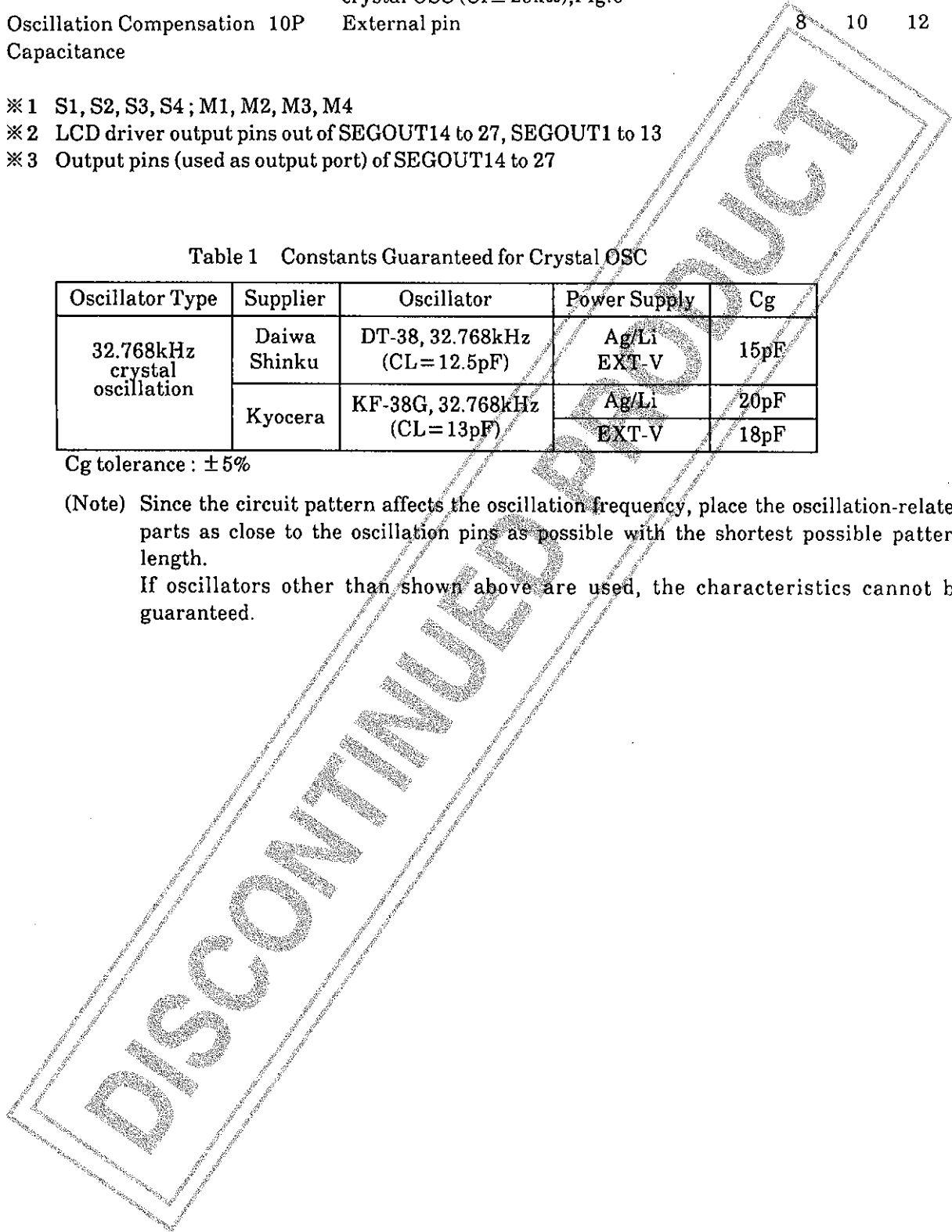
Table 1 Constants Guaranteed for Crystal OSC

Oscillator Type	Supplier	Oscillator	Power Supply	Cg
32.768kHz crystal oscillation	Daiwa Shinku	DT-38, 32.768kHz (CL=12.5pF)	Ag/Li EXT-V	15pF
	Kyocera	KF-38G, 32.768kHz (CL=13pF)	Ag/Li	20pF
			EXT-V	18pF

Cg tolerance : $\pm 5\%$

(Note) Since the circuit pattern affects the oscillation frequency, place the oscillation-related parts as close to the oscillation pins as possible with the shortest possible pattern length.

If oscillators other than shown above are used, the characteristics cannot be guaranteed.



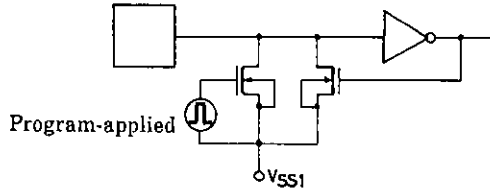


Fig.1 Input configuration of S1-4, M1-4

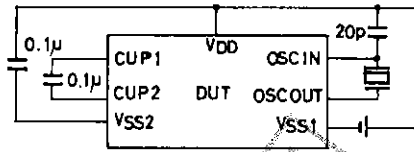


Fig.2 Current dissipation, output voltage test circuit

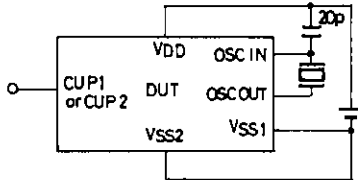


Fig.3 Oscillation start voltage, oscillation start time, frequency stability, oscillation hold voltage test circuit

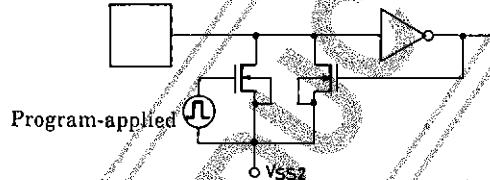


Fig.4 Input configuration of S1-4, M1-4

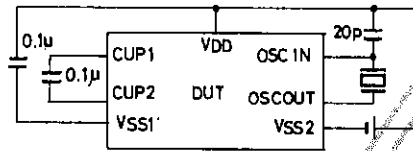


Fig.5 Current dissipation, output voltage test circuit

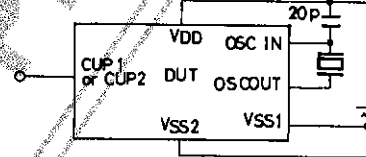


Fig.6 Oscillation start voltage, oscillation start time, frequency stability, oscillation hold voltage test circuit

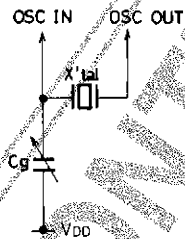


Fig.7 Recommended crystal oscillation circuit

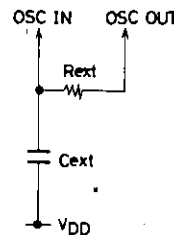


Fig.8 Recommended CR oscillation circuit

Unit (capacitance: F)

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